

The Altera® Enpirion® EY1602 is a wide input voltage range, low quiescent current linear regulator ideally suited for “always-on” and “keep alive” applications. The EY1602 operates from an input voltage of +6V to +40V under normal operating conditions, consuming only 18µA of quiescent current at no load.

The EY1602 has an adjustable output voltage range from 2.5 to 12V. It features an EN pin that can be used to put the device into a low-quiescent current shutdown mode where it draws only 1.8µA of supply current. The device features automatic thermal shutdown and current limit protection.

The EY1602 is rated over the -40°C to +125°C temperature range and is available in an 8 lead EPSONIC with exposed pad package..

**TABLE 1. KEY DIFFERENCES IN FAMILY OF 40V LDO PARTS**

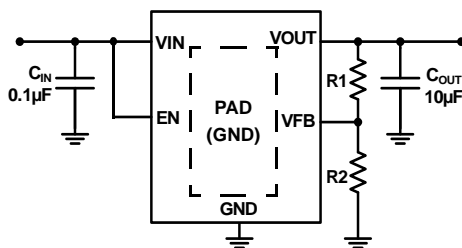
PART NUMBER	MIN. I <sub>OUT</sub>	ADJ OR FIXED V <sub>OUT</sub>
EY1602SI-ADJ	50mA	ADJ
EY1603TI-ADJ	150mA	ADJ

## Features

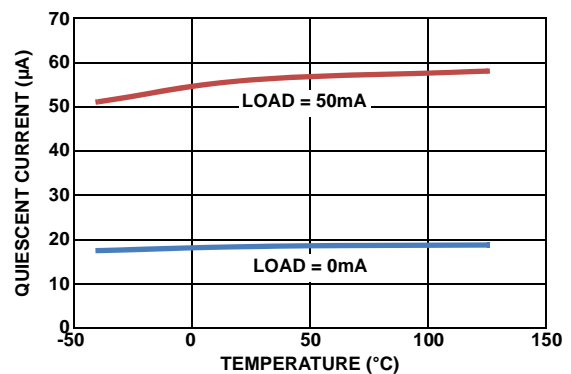
- Wide V<sub>IN</sub> range of 6V to 40V
- Adjustable output voltage from 2.5V to 12V
- Guaranteed 50mA output current
- Ultra low 18µA typical quiescent current
- Low 1.8µA of typical shutdown current
- ±1% accurate voltage reference
- Low dropout voltage of 120mV at 50mA
- 40V tolerant logic level (TTL/CMOS) enable input
- Stable operation with 10µF output capacitor
- 5kV ESD HBM rated
- Thermal shutdown and current limit protection

## Applications

- FPGA applications
- Industrial
- Networking
- Telecom



**FIGURE 1. TYPICAL APPLICATION**



**FIGURE 2. QUIESCENT CURRENT vs LOAD CURRENT (AT UNITY GAIN), V<sub>IN</sub> = 14V**

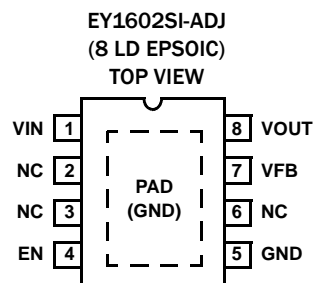
## Ordering Information

PART NUMBER	PART MARKING	TEMP. RANGE (°C)	ENABLE PIN	OUTPUT VOLTAGE (V)	PACKAGE (Pb-Free)	PKG. DWG. #
EY1602SI-ADJ (Notes 1)	1602AS	-40 to +125	Yes	Adjustable	8 Ld EPOIC	M8.15B
EVB-EY1602SI-ADJ	Evaluation Platform					

### NOTES:

1. Add “-T\*” suffix for tape and reel.
2. These Altera Enpirion Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Altera Enpirion Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

## Pin Configuration



## Pin Descriptions

PIN NUMBER	PIN NAME	DESCRIPTION
1	VIN	Input voltage pin. A minimum 0.1 $\mu$ F X5R/X7R capacitor is required for proper operation. Range: 6V to 40V
2, 3, 6	NC	Pins have internal termination and can be left not connected. Connection to ground is optional.
4	EN	High on this pin enables the device. Range: 0V to $V_{IN}$
5	GND	Ground pin.
7	VFB	This pin is connected to the external feedback resistor divider, which sets the LDO output voltage. Range: 0V to 3V
8	VOUT	Regulated output voltage. A 10 $\mu$ F X5R/X7R output capacitor is required for stability. Range: 0V to 12V
-	PAD	It is recommended to solder the PAD to the ground plane.

## Absolute Maximum Ratings

VIN Pin to GND Voltage	GND - 0.3V to +45V
VOU Pin to GND Voltage	GND - 0.3V to 16V
EN Pin to GND Voltage	GND - 0.3V to VIN
VFB Pin to GND Voltage	GND - 0.3V to 3V
Output Short-circuit Duration	Indefinite
ESD Rating	
Human Body Model (Tested per JESD22-A114E)	5kV
Machine Model (Tested per JESD-A115-A)	200V
Charge Device Model (Tested per JESD22-C101C)	2.2kV
Latch Up (Tested per JESD78B; Class II, Level A)	100mA

## Thermal Information

Thermal Resistance (Typical)	$\theta_{JA}$ (°C/W)	$\theta_{JC}$ (°C/W)
8 Ld EPSON Package (Notes 3,4)	50	9
Maximum Junction Temperature	+150°C	
Maximum Storage Temperature Range	-65°C to +175°C	
Pb-Free Reflow Profile	—	

## Recommended Operating Conditions

Ambient Temperature Range	-40°C to +125°C
VIN Pin to GND Voltage	+6V to +40V
VOU Pin to GND Voltage	+2.5V to +12V
EN Pin to GND Voltage	0V to +40V

**CAUTION:** Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

### NOTES:

- $\theta_{JA}$  is measured in free air with the component mounted on a high effective thermal conductivity test board with “direct attach” features.
- For  $\theta_{JC}$ , the “case temp” location is the center of the exposed metal pad on the package underside.

**Electrical Specifications** Recommended Operating Conditions, unless otherwise noted.  $V_{IN} = 14V$ ,  $I_{OUT} = 1mA$ ,  $C_{IN} = 0.1\mu F$ ,  $C_{OUT} = 10\mu F$ ,  $T_A = T_J = -40^\circ C$  to  $+125^\circ C$ , unless otherwise noted. Typical specifications are at  $T_A = +25^\circ C$ . **Boldface limits apply over the operating temperature range, -40°C to +125°C.**

PARAMETER	SYMBOL	TEST CONDITIONS	MIN (Note 7)	TYP	MAX (Note 7)	UNIT
Input Voltage Range	$V_{IN}$		<b>6</b>		<b>40</b>	V
Guaranteed Output Current	$I_{OUT}$	$V_{IN} = V_{OUT} + V_{DO}$	<b>50</b>			mA
VFB Reference Voltage	$V_{REF}$	EN = High, $V_{IN} = 14V$ , $I_{OUT} = 0.1mA$	<b>1.211</b>	1.223	<b>1.235</b>	V
Line Regulation	$\Delta V_{OUT}/\Delta V_{IN}$	$3V \leq V_{IN} \leq 40V$ , $I_{OUT} = 1mA$		0.04	<b>0.115</b>	%
Load Regulation	$\Delta V_{OUT}/\Delta I_{OUT}$	$V_{IN} = V_{OUT} + V_{DO}$ , $I_{OUT} = 100\mu A$ to 50mA		0.25	<b>0.5</b>	%
Dropout Voltage (Note 5)	$\Delta V_{DO}$	$I_{OUT} = 1mA$ , $V_{OUT} = 3.3V$		10	<b>38</b>	mV
		$I_{OUT} = 50mA$ , $V_{OUT} = 3.3V$		130	<b>340</b>	mV
		$I_{OUT} = 1mA$ , $V_{OUT} = 5V$		10	<b>48</b>	mV
		$I_{OUT} = 50mA$ , $V_{OUT} = 5V$		120	<b>350</b>	mV
Shutdown Current	$I_{SHDN}$	EN = LOW		1.8	<b>3.64</b>	$\mu A$
Quiescent Current	IQ	EN = HIGH, $I_{OUT} = 0mA$		18	<b>24</b>	$\mu A$
		EN = HIGH, $I_{OUT} = 1mA$		22	<b>42</b>	$\mu A$
		EN = HIGH, $I_{OUT} = 10mA$		34	<b>60</b>	$\mu A$
		EN = HIGH, $I_{OUT} = 50mA$		56	<b>82</b>	$\mu A$
Power Supply Rejection Ratio	PSRR	$f = 100Hz$ ; $V_{in\_ripple} = 500mV_{p-p}$ ; Load = 50mA		58		dB
<b>EN FUNCTION</b>						
EN Threshold Voltage	$V_{EN\_H}$	$V_{OUT} = \text{Off to On}$			<b>1.485</b>	V
	$V_{EN\_L}$	$V_{OUT} = \text{On to Off}$	<b>0.935</b>			V
EN Pin Current	$I_{EN}$	$V_{OUT} = 0V$		0.026		$\mu A$
EN to Regulation Time (Note 6)	$t_{EN}$			1.65	<b>1.93</b>	ms
<b>PROTECTION FEATURES</b>						
Output Current Limit	$I_{LIMIT}$	$V_{OUT} = 0V$	<b>60</b>	118		mA

**Electrical Specifications** Recommended Operating Conditions, unless otherwise noted.  $V_{IN} = 14V$ ,  $I_{OUT} = 1mA$ ,  $C_{IN} = 0.1\mu F$ ,  $C_{OUT} = 10\mu F$ ,  $T_A = T_J = -40^\circ C$  to  $+125^\circ C$ , unless otherwise noted. Typical specifications are at  $T_A = +25^\circ C$ . **Boldface limits apply over the operating temperature range,  $-40^\circ C$  to  $+125^\circ C$ .** (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN (Note 7)	TYP	MAX (Note 7)	UNIT
Thermal Shutdown	$T_{SHDN}$	Junction Temperature Rising		+165		$^\circ C$
Thermal Shutdown Hysteresis	$T_{HYST}$			+20		$^\circ C$

**NOTES:**

- Dropout voltage is defined as  $(V_{IN} - V_{OUT})$  when  $V_{OUT}$  is 2% below the value of  $V_{OUT}$  when  $V_{IN} = V_{OUT} + 3V$ .
- Enable to Regulation is the time the output takes to reach 95% of its final value with  $V_{IN} = 14V$  and EN is taken from  $V_{IL}$  to  $V_{IH}$  in 5ns. The output voltage is set at 5V.
- Parameters with MIN and/or MAX limits are 100% tested at  $+25^\circ C$ , unless otherwise specified. Temperature limits established by characterization and are not production tested.

# Typical Performance Curves $V_{IN} = 14V, I_{OUT} = 1mA, V_{OUT} = 5V, T_J = +25^\circ C$ unless otherwise specified.

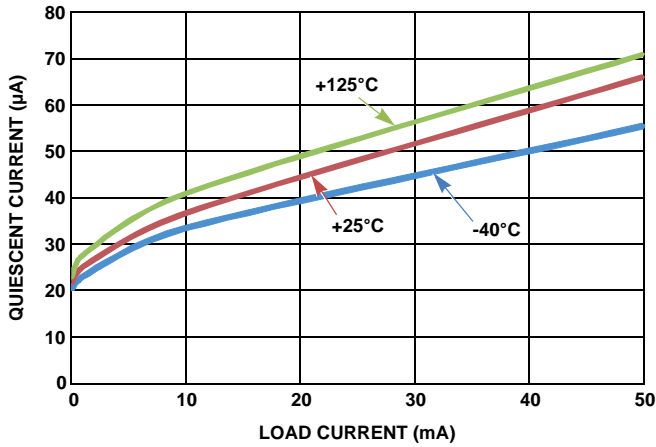


FIGURE 3. QUIESCENT CURRENT vs LOAD CURRENT

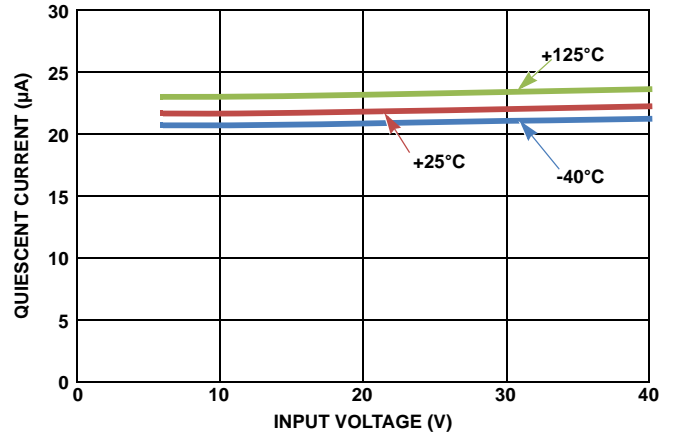


FIGURE 4. QUIESCENT CURRENT vs INPUT VOLTAGE (NO LOAD)

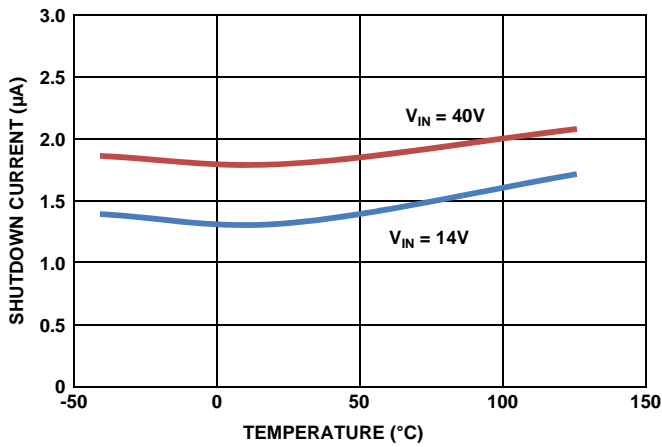


FIGURE 5. SHUTDOWN CURRENT vs TEMPERATURE (EN = 0)

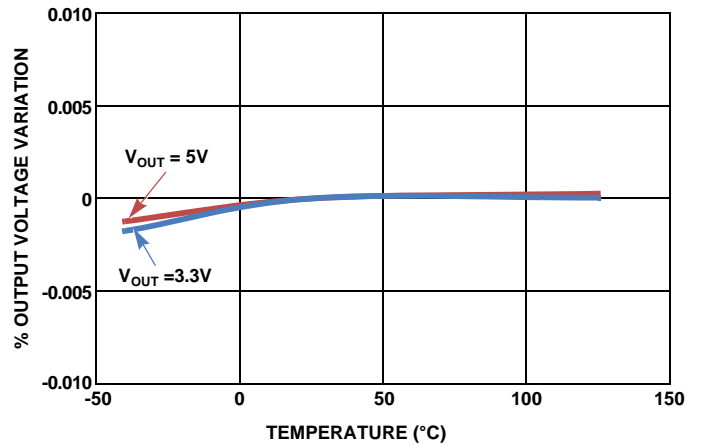


FIGURE 6. OUTPUT VOLTAGE vs TEMPERATURE (LOAD = 50mA)

# Typical Performance Curves $V_{IN} = 14V, I_{OUT} = 1mA, V_{OUT} = 5V, T_J = +25^\circ C$ unless otherwise specified. (Continued)

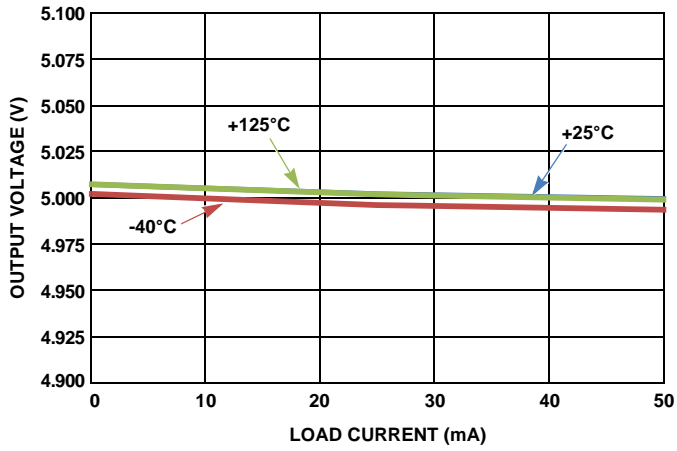


FIGURE 7. OUTPUT VOLTAGE vs LOAD CURRENT

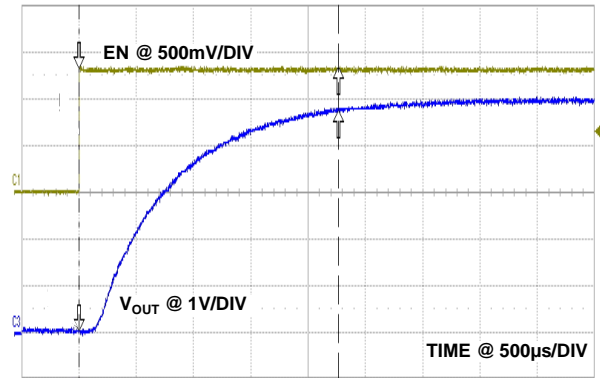


FIGURE 8. START-UP WAVEFORM

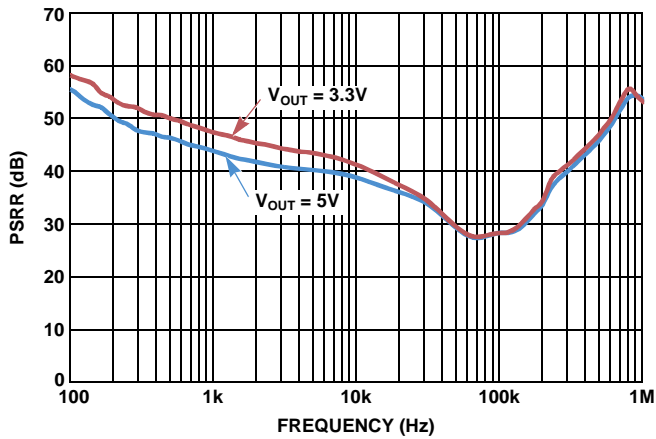


FIGURE 9. POWER SUPPLY REJECTION RATIO (LOAD = 50mA)

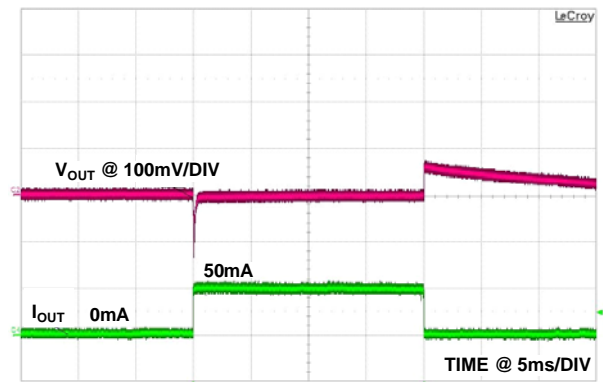
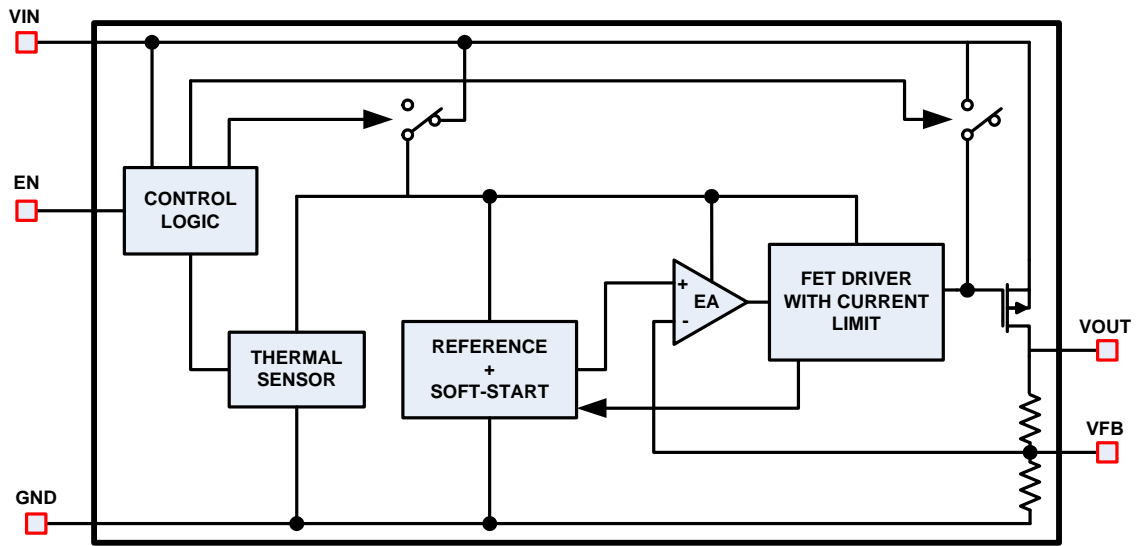


FIGURE 10. LOAD TRANSIENT RESPONSE

## Block Diagram



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## Functional Description

### Functional Overview

The EY1602 is a high performance, high voltage, low-dropout regulator (LDO) with 50mA sourcing capability. The part is rated to operate over the  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  temperature range. Featuring ultra-low quiescent current, it makes an ideal choice for “always-on” applications. It works well under a “load dump condition” where the input voltage could rise up to 40V. The device also features current limit and thermal shutdown protection.

### Enable Control

The EY1602 features an Enable pin. When it is pulled low, the IC goes into shutdown mode. In this condition, the device draws less than  $2\mu\text{A}$ . Driving the pin high turns the device on. For always on operation, the EN pin can be tied directly to VIN.

### Current Limit Protection

The EY1602 has internal current limit functionality to protect the regulator during fault conditions. During current limit, the output sources a fixed amount of current largely independent of the output voltage. If the short or overload is removed from VOUT, the output returns to normal voltage regulation mode.

### Thermal Fault Protection

In the event that the die temperature exceeds typically  $+165^{\circ}\text{C}$ , the output of the LDO will shut down until the die temperature cools down to typically  $+145^{\circ}\text{C}$ . The level of power dissipated, combined with the ambient temperature and the thermal impedance of the package, will determine if the junction temperature exceeds the thermal shutdown temperature. Also see the section on “Power Dissipation”.

## Application Information

### Input and Output Capacitors

For the output, a ceramic capacitor (X5R or X7R) with a capacitance of  $10\mu\text{F}$  is recommended for the EY1602 to maintain stability. The ground connection of the output capacitor should be routed directly to the GND pin of the device and also placed close to the IC. A minimum of  $0.1\mu\text{F}$  (X5R or X7R) is recommended at the input.



## Output Voltage Setting

The output voltage is programmed using an external resistor divider, as shown in Figure 11.

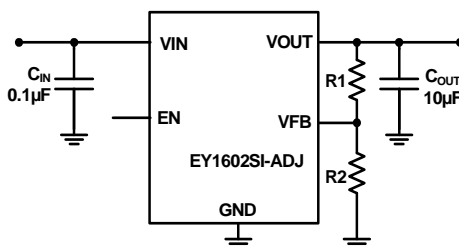


FIGURE 11. SETTING OUTPUT VOLTAGE

The output voltage is calculated using Equation 1:

$$V_{OUT} = 1.223V \times \left( \frac{R1}{R2} + 1 \right) \quad (\text{EQ. 1})$$

## Power Dissipation

The junction temperature must not exceed the range specified in “Recommended Operating Conditions” on page 3. The power dissipation can be calculated using Equation 2:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_{GND} \quad (\text{EQ. 2})$$

The maximum allowable junction temperature,  $T_{J(MAX)}$  and the maximum expected ambient temperature,  $T_{A(MAX)}$  will determine the maximum allowable junction temperature rise ( $\Delta T_J$ ), as shown in Equation 3:

$$\Delta T_J = T_{J(MAX)} - T_{A(MAX)} \quad (\text{EQ. 3})$$

To calculate the maximum ambient operating temperature, use the junction-to-ambient thermal resistance ( $\theta_{JA}$ ), as shown in Equation 4:

$$T_{J(MAX)} = P_{D(MAX)} \times \theta_{JA} + T_A \quad (\text{EQ. 4})$$

## Board Layout Recommendations

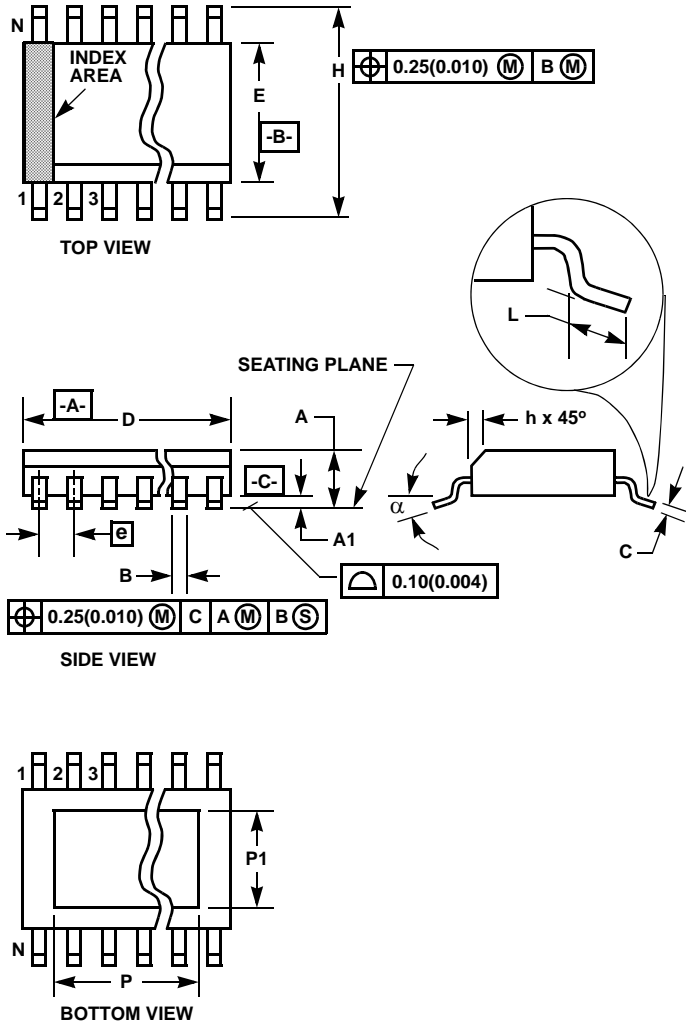
A good PCB layout is important to achieve expected performance. Consideration should be taken when placing the components and routing the trace to minimize the ground impedance, and keep the parasitic inductance low. The input and output capacitors should have a good ground connection and be placed as close to the IC as possible. The VFB feedback trace should be away from other noisy traces. Connect the exposed pad to the ground plane for better heat dissipation. Thermal vias on the PAD increases heat dissipation.

## Document Revision History

The table lists the revision history for this document.

Date	Version	Changes
February 2014	1.0	Initial release.

### Small Outline Exposed Pad Plastic Packages (EPSONIC)



**M8.15B**  
**8 LEAD NARROW BODY SMALL OUTLINE EXPOSED PAD**  
**PLASTIC PACKAGE**

SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.056	0.066	1.43	1.68	-
A1	0.001	0.005	0.03	0.13	-
B	0.0138	0.0192	0.35	0.49	9
C	0.0075	0.0098	0.19	0.25	-
D	0.189	0.196	4.80	4.98	3
E	0.150	0.157	3.81	3.99	4
e	0.050 BSC		1.27 BSC		-
H	0.230	0.244	5.84	6.20	-
h	0.010	0.016	0.25	0.41	5
L	0.016	0.035	0.41	0.89	6
N	8		8		7
$\alpha$	0°	8°	0°	8°	-
P	-	0.094	-	2.387	11
P1	-	0.094	-	2.387	11

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**NOTES:**

1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
4. Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
6. "L" is the length of terminal for soldering to a substrate.
7. "N" is the number of terminal positions.
8. Terminal numbers are shown for reference only.
9. The lead width "B", as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch).
10. Controlling dimension: INCH. Converted millimeter dimensions are not necessarily exact.
11. Dimensions "P" and "P1" are thermal and/or electrical enhanced variations. Values shown are maximum size of exposed pad within lead count and body size.

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